PRODUCERS' QUESTIONNAIRE DRAMS AND DRAM MODULES FROM KOREA

Return completed questionnaire to:

UNITED STATES INTERNATIONAL TRADE COMMISSION

Office of Investigations, Room 615 500 E Street, SW, Washington, DC 20436

So as to be received by the Commission by no later than November 15, 2002

The information called for in this questionnaire is for use by the United States International Trade Commission in connection with its countervailing duty investigation concerning DRAMs and DRAM modules from Korea (inv. No. 701-TA-431 (Preliminary)). The information requested in the questionnaire is requested under the authority of the Tariff Act of 1930, title VII. This report is mandatory and failure to reply as directed can result in a subpoena or other order to compel the submission of records or information in your possession (19 U.S.C. § 1333(a)).

Name of	·		
			7:)
	/ide Web address		_
	rm produced DRAMs or DRAM modules		
\square_{NO}	(Sign the certification below and promptl	ly return only this page of the qu	nestionnaire to the Commission)
YES	(Read the instruction booklet carefully, coreturn the entire questionnaire to the Com	omplete all parts of the question numission)	naire, sign the certification, and
ef and unders signing this ce vided in this qu the same or si	nformation herein supplied in response to the tand that the information submitted is substand that the information submitted is substantification I also grant consent for the Commestionnaire and throughout this investigation milar merchandise. (If you do not consent that information submitted in this question	ject to audit and verification by mission, and its employees and c on in any other import-injury inv t to such use, please note the ce	o the Commission. contract personnel, to use the informativestigations conducted by the Commissivetification accordingly.)
nmission, its d Intaining the restigations rel	employees, and contract personnel who a ecords of this investigation or related proceating to the programs and operations of the will sign non-disclosure agreements.	re acting in the capacity of Co eedings for which this informat	ommission employees, for developing ion is submitted, or in internal audits a
me and Title	of Authorized Official	Date	
	thorized Official	<u> </u>	<u>()</u>
ηστυν <i>ο</i> οτ Απ	inorizea (Jiiiciai	Phone	Fax

PART I.-GENERAL QUESTIONS

The questions in this questionnaire have been reviewed with market participants to ensure that issues of concern are adequately addressed and that data requests are sufficient, meaningful, and as limited as possible. Public reporting burden for this questionnaire is estimated to average 60 hours per response, including the time for reviewing instructions, searching existing data sources, gathering the data needed, and completing and reviewing the questionnaire. Send comments regarding the accuracy of this burden estimate or any other aspect of this collection of information, including suggestions for reducing the burden, to the Office of Investigations, U.S. International Trade Commission, 500 E Street, SW, Washington, DC 20436.

		l number of hours d completing the f		e cost to your firm of preparing the
h	ours	dol	lars	
instruction b		ing guidelines). It		his questionnaire (see page 3 of the blicly traded, please specify the
Do you supp	ort or oppose the	e petition? Please	explain.	
Support	Oppose	Take no po	osition	
and a counte Act of 1930, possible distribusiness proj	rvailing duty ord will provide a li ribution of any c prietary treatmer	ler is issued, the C st of firms suppor ountervailing duti nt of your response	commission, pursiting the petition es that may be controlled to this question	in the investigation is affirmative suant to section 754 of the Tariff to the Customs Service for ollected. If you wish to waive in order to make your position firm on that list, indicate "yes"
Yes	No (that	is, I do not wish n	ny position on th	e petition to be made public)
Is your firm	owned, in whole	or in part, by any	other firm?	
No	YesLis	t the following inf	formation.	
Firm name		Address		Extent of ownership
		Audiess		<u>ownership</u>

PART I.--GENERAL QUESTIONS--Continued

I-5.	Does your firm have any related firms, either domestic or foreign, which are engaged in importing DRAMs or DRAM modules from Korea into the United States or which are engaged in exporting DRAMs or DRAM modules from Korea to the United States?						
	No	YesLis	st the following in	formation.			
	Firm name		Address		Affiliation		
I-6.			ated firms, either d	omestic or foreign,	which are engaged in	n the	
	□No	YesLis	st the following in	formation.			
	Firm name		Address		<u>Affiliation</u>		
PART	II <u>TRADE</u>	AND RELATE	ED INFORMATION	<u>ON</u>			
			e questionnaire ca endar-year basis.	n be obtained from l	Mary Messer (202-20	05-3193).	
II-1.	Who should b	e contacted reg	garding the reques	ted trade and related	information?		
	Company cor	ntact: Name a	nd title				
		Phone N	lo.	E-mail ad	dress		
II-2.	consolidation curtailment o	s, closures, or production be tions or organized	orolonged shutdow cause of shortages	of materials; or any	ions, acquisitions, s or equipment failur other change in the AMs or DRAM mod	character	
	□No	YesSu	pply details as to t	he time, nature, and	significance of such	changes.	

<u>Product</u>	Basis for allocation of capacity data
	the percent of your total wafer starts accounted for by DRAM wafers for each periods. 1999:%, 2000:%, 2001:%, JanSept. 2002 _
	e the constraint(s) that set the limit(s) on your production capabilities, reporting design, wafer fabrication, assembly, and testing.
	n produce other products (e.g., logic devices, SRAM modules, flash memory) action and related workers employed to produce DRAMs or DRAM modules
	n produce other products (e.g., logic devices, SRAM modules, flash memory) action and related workers employed to produce DRAMs or DRAM modules YesList the following information.
the same produ	uction and related workers employed to produce DRAMs or DRAM modules
the same produ	uction and related workers employed to produce DRAMs or DRAM modules YesList the following information.
the same produ	uction and related workers employed to produce DRAMs or DRAM modules YesList the following information.
Is your firm at response to a r	uction and related workers employed to produce DRAMs or DRAM modules YesList the following information.

II-7.	Since January 1, 1999, has your firm been involved in a toll agreement (see definition in the instruction booklet) regarding the production of DRAMs or DRAM modules?
	No YesName firm:
II-8.	Does your firm produce DRAMs or DRAM modules in a foreign trade zone (FTZ)?
	No YesIdentify FTZ(s):
II - 9.	Since January 1, 1999, has your firm imported DRAMs or DRAM modules?
	No Yes <u>COMPLETE AND RETURN THE ENCLOSED IMPORTERS'</u> <u>QUESTIONNAIRE</u>
II-10.	The following questions relate to your firm's captive consumption of DRAMs or DRAM modules, in the production of downstream product(s). <u>NOTE</u> For purposes of this question, do not report cased DRAMs as a downstream product of uncased DRAMs, or DRAM modules as a downstream product of cased DRAMs.
	a). Does your firm internally transfer or sell to any related firm, any portion of its production of DRAMs or DRAM modules for use in the production of downstream product(s)?
	\square No \square Yes – Complete the questions below.
	b). Please identify the downstream product(s) in the production of which your firm, or related firm, captively consumes DRAMs or DRAM modules. Use additional pages as necessary.
	c). Please report the percentage of your firm's production of DRAMs or DRAM modules that was used in the production of downstream product(s) by your firm or related firm in the following years. 1999: percent; 2000: percent; and 2001: percent.
	d). Do the downstream product(s) for which your firm internally transfers or captively consumes DRAMs or DRAM modules compete for sales in the merchant market with DRAMs or DRAM modules? Please explain your answers.

II-11.	Describe the significance of the antidumping duty order covering imports of non-Samsung Korean DRAMs \$ 1-Meg and DRAM modules containing any DRAMs \$ 1-Meg that was in effect from May 10, 1993, until October 5, 2000, in terms of its effect on your firm with regard to the below listed items and any others you consider appropriate. You may wish to compare your firm's operations before and after the imposition of the order, and before and after the revocation of the order. If appropriate, include a discussion of the effect(s), if any, of changes in the dumping margins. Attach additional pages, as needed.						
	(a) Production	on capacity, produc	etion, shipments, inventories, purchases, and employment:				
			ty to generate capital to finance the modernization of U.S. plant(s) aintain existing levels of expenditures for research and development				
II-12.	and indicate	whether your prod L THAT APPLY.	AM module products that your firm produces in the United States, luction is for the merchant market or for captive consumption. Note"3 rd country" refers to countries other than Korea and the				
	Merchant market	Captive consumption	<u>Product</u>				
			Uncased DRAMs (fabricated dice) Cased DRAMs from U.Sfabricated dice Cased DRAMs from Korean-fabricated dice Cased DRAMs from all-other-source-fabricated dice DRAM modules made from cased DRAMs that were cased in— The United States from U.Sfabricated dice Korea from U.Sfabricated dice 3rd countries from U.Sfabricated dice The United States from Korean-fabricated dice Korea from Korean-fabricated dice 3rd countries from Korean-fabricated dice The United States from 3rd-country-fabricated dice Korea from 3rd-country-fabricated dice The United States from 3rd-country-fabricated dice				

II-13. <u>ALL DRAMS</u>.--For your U.S. establishment(s) wherein DRAM wafers are fabricated (UNCASED DRAMS), assembled (CASED), and/or assembled into modules, report the average-of-period full production capabilities (i.e., capacity--see definitions in instructions booklet). In reporting the capacity and wafer starts requested below for UNCASED DRAMS, please consider the capacity utilization (i.e., wafer starts divided by capacity) experienced by your U.S. establishments wherein DRAM wafers are fabricated. Also, estimate for each period the probe yield (i.e., the percentage of usable die per wafer). For CASED DRAMS, please consider the capacity utilization (i.e., assembly divided by assembly capacity) of your DRAM assembly facilities.

capacity) of your DRAM assembly fa	icililes.			1	
		Calendar yeaı	rs	January-September	
Item	1999	2000	2001	2001	2002
UNCASED DRAMS: ¹ Average capacity ² (1,000 8-inch-equivalent wafers)					
Wafer starts (1,000 8-inch- equivalent wafers)					
Probe yield (percent)					
CASED DRAMS: Average capacity³ (1,000 units)					
Assembly ⁴ (1,000 units)					
DRAM MODULES: Average capacity ⁵ (1,000 units)					
Assembly (1,000 units)					
² The average capacity reported is based or explain assumptions made and methods used fabricate DRAM wafers. Also explain any charnecessary.	n operating in calculating iges in reporte	hours pe	er week,	for practical ca	ar. Briefly pacity to
³ The average capacity reported is based or explain assumptions made and methods used assemble DRAMs. Also explain any changes in necessary.	in calculating	the estimates	reported above	for average ca	ar. Briefly pacity to
⁴ The data reported for all DRAMs assemble DRAMs reported in question II-15. If data do n necessary.	ot reconcile, p	al the totals of please explain,	production for a using additional	all densities of a	all cased
⁵ The average capacity reported is based or explain assumptions made and methods used assemble DRAM modules. Also explain any class necessary.	in calculating nanges in repo	the estimates	reported above	for average ca	ar. Briefly pacity to

II-14. UNCASED DRAMS FABRICATE shipments, and inventories related to during the specified periods. Report photocopying this page as necessar	the production the separately in the separately	on of uncased for each densithe density re	DRAMs in you ity of DRAM	ur U.S. establi your firm pro	ishment(s) oduces,
appropriate box. (See definitions in ☐ 16 Meg ☐ 64 Meg ☐ 128 Meg ☐		,	Other (specify de	nsity	
	Calendar years			January-September	
Item	1999	2000	2001	2001	2002
Beginning-of-period inventories (1,000 units)					
PRODUCTION: ¹ Quantity (1,000 units)					
Value ² (\$1,000)					
U.S. SHIPMENTS: U.S. company transfers/internal consumption for making cased DRAMs: Quantity (1,000 units)					
Value³ (\$1,000)					
Other U.S. company transfers (please identify the nature of the transfers:					
Quantity (1,000 units)		<u></u>	<u></u>		
Value³ (<i>value</i>)					
Domestic commercial shipments: ⁴ Quantity (1,000 units)					
Value (\$1,000)		T			
EXPORT SHIPMENTS: Company transfers to foreign affiliates: ⁵ Quantity (1,000 units)					
Value³ (\$1,000)					
Other export shipments: ⁶ Quantity (1,000 units)					
Value (\$1,000)					
End-of-period inventories ⁷ (1,000 units)					
1 Reported production should include only usa sorting). 2 Please report the cost of production. 3 Internal consumption and transfers to related different basis for valuing these transactions, plead using that basis for 1999, 2000, 2001, and January.	d firms must be	e valued at fair n at basis (e.g., co	market value. In	the event that y	you use a
⁴ List your customers:					
⁵ Identify foreign affiliate(s) and location(s).					
⁶ Identify your principal export markets:					
 ⁷ Reconciliation of dataPlease note that the inventories, plus production, less total shipments, ☐ Yes ☐ NoPlease explain: 	quantities rep , equals end-o	orted above shorted inventor	ould reconcile as ries. Do the data	s follows: begin a reported recor	ning-of-period ncile?

II-15.	cased Drams assembled in shipments, and inventories related to the specified periods. (See definition Dram your firm assembles, by the necessary. Identify: (1) the density checking one hay per category below.	the assembly as in the instrue location of ty, and (2) the	of cased DRA action booklet. the fabrication	AMs in your U. One of the dice,	.S. establishme arately for ea photocopying	ent(s) during ch density of g this page as
checking one box per category below. 1) Density: □ 16 Meg □ 64 Meg □ 128 Meg □ 256 Meg □ 512 Meg □ Other (specify density:						
			_		•	
2) Dice	fabrication location: United States Kor	rea	cations (specify:)
	1		Calendar years	5	January-S	eptember
	Item	1999	2000	2001	2001	2002
Begin	ning-of-period inventories (1,000 units)					
	antity (1,000 units)					
Val	lue ² (\$1,000)					
U.S sur	SHIPMENTS: 5. company transfers/internal conmption for making DRAM modules: Quantity (1,000 units)					
	Value³ (\$1,000)					
ide	ner U.S. company transfers (please entify the nature of the transfers: Quantity (1,000 units)					
	Value ³ (<i>value</i>)		 			
Do	mestic commercial shipments: Quantity (1,000 units)					
	Value (\$1,000)					
Co	RT SHIPMENTS: mpany transfers to foreign affiliates: ⁴ Quantity (1,000 units)					
	Value³ (<i>\$1,000</i>)					
	ner export shipments: ⁵ Quantity (1,000 units)					
	Value (<i>\$1,000</i>)					
End-o	f-period inventories ⁶ (1,000 units)					
addition purchate 2 Pl 3 In differe	eported production should include only usa on, reported production should include asse ased. lease report the cost of production. Iternal consumption and transfers to related nt basis for valuing these transactions, plea that basis for 1999, 2000, 2001, and Januar	embly of all dice I firms must be ase specify that	e, whether intern valued at fair m t basis (e.g., cos	nally transferred on arket value. In t	or imported or co	otherwise ou use a
	entify foreign affiliate(s) and location(s)					
⁶ Roinvento	econciliation of dataPlease note that the cories, plus production, less total shipments,	quantities repo , equals end-of-	orted above shore- period inventor	ould reconcile as ies. Do the data	follows: begini reported recon	ningof-period

☐ Yes ☐ No--Please explain:

II-16.	<u>DRAM MODULES ASSEMBLED IN THE UNITED STATES.</u> —Report your firm's assembly, shipments, and inventories related to the assembly of DRAM modules in your U.S. establishment(s)							
	during the specified periods. (See d	lefinitions in	the instruction	n booklet.) Ren	ort separatel	v for each		
	dice fabrication location/cased DF	RAMs assem	bly location o	combination. Î	Photocopy thi	s page as		
	necessary, checking one box per c			fabrication loc	ation, and (2)	cased		
	DRAM assembly location reporte	d on each pa	ige.					
		_						
1) Dice	fabrication location: \square United States \square Ko	orea	locations (specif	fy:				
2) Case	d DRAMs assembly location: United State	es Korea	Other location	ons (specify:				
		Calendar years January-September						
	Item	1999	2000	2001	2001	2002		
Begin	ning-of-period inventories (billion bits)							
	antity (billion bits)							
Val	lue² (\$1,000)							
	HIPMENTS:							
	ernal consumption/other U.S. mpany transfers (please identify the							
	ture of the consumption/transfers:							
	Quantity (billion bits)							
	Value³ (value)							
	mestic commercial shipments: Quantity (billion bits)							
	Value (\$1,000)							
Co	RT SHIPMENTS: mpany transfers to foreign affiliates: ⁴ Quantity (billion bits)							
	Value³ (<i>\$1,000</i>)							
	ner export shipments: ⁵ Quantity (<i>billion bits</i>)							
	Value (<i>\$1,000</i>)							
End-o	f-period inventories ⁶ (billion bits)							
¹ R	eported only usable modules(i.e., net of a	ny losses that	occur during as	sembly and testir	ng).	•		
² P	lease report the cost of production. ternal consumption and transfers to relate	ed firms must b	e valued at fair	market value. In	the event that	vou use a		
differe	nt basis for valuing these transactions, ple that basis for 1999, 2000, 2001, and Janu	ease specify th	at basis (e.g., o	cost, cost plus, etc	c.) and provide	value data		
4 Id	entify foreign affiliate(s) and location(s).							
	lentify your principal export markets:							
⁶ R	econciliation of dataPlease note that the	e quantities re	ported above s	should reconcile a	s follows: begin	ning-of-period		
invent	ories, plus production, less total shipment	s, equals end-	of-period invent	tories. Do the dat	a reported reco	ncile?		

II-17.	If you reported transfers to related firms in questions II-14, II-15, or II-16, please indicate the nature of the relationship between your firm and the related firms (e.g., joint venture, wholly owned subsidiary), whether the transfers were priced by market or by a non-market formula, whether your firm retained marketing rights to all transfers, and whether the related firms also processed inputs from sources other than your firm.						
II-18a.	In the following table, please estimate the shares (in per-	cent) of the v	alue of you	2001 U.S. s	hipments of		
	DRAMs and DRAM modules, by DRAM type and by lo	ocation of dic	e fabrication	n.			
			Dice fabr	icated in			
	Type of DRAM	United States	Korea	Other sources	All sources		
	Standard DRAMs, including extended data out (EDO), fast page, synchronous, and double data rate						
	Rambus						
	Other DRAM types, including video (VRAM), synchronous graphics (SGRAM), windows (WRAM), and other (please specify type(s)):						
	Total, all DRAMs				100.0		
II-18b.	In reference to the data provided in II-18a, please note g mix or source mix that transpired during January 1999-5			1 your DRAM			
II-19.	How much of the cost (raw materials, labor, and factory assets) of your firm's production of cased DRAMs is in process (or cost of purchasing uncased DRAMs)?						
	Fabrication/purchase of uncased DRAMs Assembly into cased DRAMs Total 100.0	_ percent					
II-20.	How much of the cost of your firm's production of DRA process versus the production/purchase of cased DRAM		is in the asso	embly into m	odules		
	Production/purchase of cased DRAMs	_ percent					

II-21. CASED DRAMS MADE FROM U.S.-FABRICATED DICE ASSEMBLED BY FOREIGN AFFILIATES/SUBCONTRACTORS.--Report your firm's foreign affiliates/subcontractors' shipments of cased DRAMs containing U.S. fabricated dice to the United States, and to other markets (including both shipments to the "home-market country" in which the cased DRAMs are assembled and shipments to other (non-U.S.) country markets). Report separately for each density of cased DRAMs assembled by your firm and by the foreign location where the cased DRAMs are assembled (Korea or 3rd countries (i.e., countries other than Korea and the United States)), photocopying this page as necessary. Identify the density reported for each page by checking one box, below, per page.

		Calendar year	S	January-September	
Item	1999	2000	2001	2001	2002
CASED DRAMS ASSEMBLED IN KOREA: Shipments to the United States: Quantity (1,000 units)					
Value (\$1,000)					
Internally consumed by your firm outside the U.S. to produce DRAM modules: ² Quantity (1,000 units)					
Value (\$1,000)					
U.S. export component value ³ (\$1,000)					
All other shipments, combined: ⁴ Quantity (1,000 units)					
Value (\$1,000)					
U.S. export component value ³ (\$1,000)					
CASED DRAMS ASSEMBLED IN 3 RD COUNTRIES: Shipments to the United States: ⁵ Quantity (1,000 units)					
Value (\$1,000)					
Internally consumed by your firm outside the U.S. to produce DRAM modules: ² Quantity (1,000 units)					
Value (\$1,000)					
U.S. export component value ³ (\$1,000)					
All other shipments, combined: ⁶ Quantity (1,000 units)					
Value (<i>value</i>)					
U.S. export component value ³ (\$1,000)					
¹ List the major customers of your shipments to	the United St	ates of cased D	DRAMs assembl	ed in Korea.	•
Report shipments of these modules in questio					
The U.S. export value of the U.Sfabricated u					
⁴ Including company transfers; list your major m	arkets for cas	ed DRAMS ass	sembled in Kore	a	
⁵ List your major customers of your shipments to	a tha Llaitad C	totoo of occod	DBAMe accomb	alad in 2rd accept	

II-22. DRAM MODULES ASSEMBLED BY FOREIGN AFFILIATES/SUBCONTRACTORS FROM U.S.-FABRICATED DICE AND/OR 3RD-COUNTRY DICE ASSEMBLED INTO CASED DRAMS IN THE UNITED STATES.--Report your firm's foreign affiliates/subcontractors' shipments of DRAM modules containing (1) U.S. fabricated dice, regardless of where assembled into cased DRAMs, or (2) cased DRAMs assembled in the United States from 3rd-country-fabricated dice (i.e., non-Korean and non-U.S. fabrication); identify whether these shipments are to the United States or to other markets (including both shipments to the "home-market country" in which the DRAM modules are assembled and shipments to other (non-U.S.) country markets). Report separately for each dice fabrication/cased DRAM assembly combination indicated. Photocopy page as needed.

Cased DRAMs assembled in the United States from	U.Sfabricated	l dice			
Cased DRAMs assembled in Korea from U.Sfabri	cated dice				
☐ Cased DRAMs assembled in 3 rd countries (those oth	ner than Korea a	nd the United St	ates) from U.Sfa	abricated dice	
Cased DRAMs assembled in the United States from	dice fabricated	in 3 rd countries			
		Calendar year	rs	January-S	eptember
Item	1999	2000	2001	2001	2002
DRAM MODULES ASSEMBLED IN KOREA: Shipments to the United States:1 Quantity (billion bits)					
Value (\$1,000)					
All other shipments, combined: ² Quantity (billion bits)					
Value (\$1,000)					
U.S. export component value ³ (\$1,000)					
DRAM MODULES ASSEMBLED IN 3 RD COUNTRIES: Shipments to the United States: ⁴ Quantity (billion bits)					
Value (<i>\$1,000</i>)					
All other shipments, combined: ⁵ Quantity (billion bits)					
Value (<i>value</i>)					
U.S. export component value ³					
¹ List your major customers of your shipments	to the United	States of DRAM	1 modules asser	mbled in Korea.	
² Including your company transfers; list your m	ajor markets f	or DRAM modu	les assembled i	n Korea.	
³ The U.S. export value of U.Scased DRAMs assembled into cased DRAMs by your foreign aff reported on the previous page). ⁴ List your major customers of your shipments	iliates/subcont	ractors in Korea	a or 3 rd countries	s (which should h	nave been
⁵ Including your company transfers; list your m	najor markets f	or DRAM modu	les assembled i	n 3 rd countries.	

II-23. PURCHASES OF UNCASED DRA your firm purchased uncased DRAM					
□ No □ YesReport such properties of the prop	n density your product, phot r use of the pro	firm purchar tocopying this oduct, by chec	ses, by source s page as nece cking one box	e of dice fabric essary. Identif each for categ	fy: (1) the
2) <u>Use of product:</u> For cased DRAM production	For resale	For other uses	s (specify:)
		Calendar years	1	January-S	September
Item	1999	2000	2001	2001	2002
PURCHASES OF UNCASED DRAMS, BY ORIGIN OF DICE: ^{1 2} U.Sfabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
Korean-fabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
Other-source fabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
¹ Please indicate your reasons for purchasing	this product. If	your reasons d	liffer by source,	please elaborat	e
² Please list the name of the firm(s) from whic identify the source for each listed supplier.	h you purchased	d this product.	If your suppliers	differ by source	e, please

II-24. PURCHASES OF CASED DRAM firm purchased cased DRAMs since					
☐ No ☐ YesReport such puseparately for each location of cased Dithis page as necessary assembly, and (3) you and 3 below.	density your RAM assembary. Identify:	firm purchased by your firm purchased by your firm (1) the densit	ses, by source ur use of the ty, and (2) loca	e of dice fabric product, phot ation of cased	tocopying DRAM
1) <u>Density</u> : ☐ 16 Meg ☐ 64 Meg ☐ 128 Meg	□ 256 Meg □	3 512 Meg □ (Other (specify de	nsity)	
2) <u>Location of cased DRAM assembly:</u> United Sta	ites	Locations of	ther than Korea o	r the United State	es
3) <u>Use of product:</u> For DRAM module production	☐ For resale	For other use	es (specify:		_)
		Calendar years	5	January-S	September
Item	1999	2000	2001	2001	2002
PURCHASES OF CASED DRAMS, BY ORIGIN OF DICE: ^{1 2} U.Sfabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
Korean-fabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
Other-source fabricated dice: Quantity (1,000 units)					
Value (\$1,000)					
Please indicate your reasons for purchasing	this product. If	your reasons d	iffer by source,	please elaborat	e.
² Please list the name of the firm(s) from which identify the source for each listed supplier.	h you purchase	d this product.	If your suppliers	differ by source	e, please

II-25. PURCHASES OF DRAM MODUL your firm purchased DRAM modules					* ·
☐ No ☐ YesReport such pueach location of dicolocation of assembly photocopying page location of assembly checking one box ea	ce fabrication by into modul as necessary y into cased D	n, location of a les, and use of y. Identify (1) ORAMs, and (3)	the location of your use of	cased DRAM ed product co of module asser	Is, and mbination, mbly, (2) the
1) <u>Location of module assembly:</u> United States	□Korea □I	Locations other tha	an Korea or the U	Jnited States	
2) <u>Location of assembly into cased DRAMs</u> : Unite	ed States	Korea Locatio	ons other than K	orea or the United	1 States
3) <u>Use of DRAM modules:</u>	ner uses (specify	y:		_	
		Calendar years	 S	January-S	September
Item	1999	2000	2001	2001	2002
PURCHASES OF DRAM MODULES, BY ORIGIN OF DICE: ^{1 2} U.Sfabricated dice: Quantity (billion bits)					
Value (\$1,000)					
Korean-fabricated dice: Quantity (billion bits)					
Value (\$1,000)	<u> </u>		<u> </u>		
Other-source fabricated dice: Quantity (billion bits)					
Value (\$1,000)					
Please indicate your reasons for purchasing	this product.	if your reasons u	Iffer by source,	please elaboral	ie.
² Please list the name of the firm(s) from which identify the source for each listed supplier.	-	•	-	s differ by sourc	e, please

	DRAM module assembly	
	Cased DRAM assembly	
	Uncased DRAM fabrication	
	Operation	Countries
II-29.	Please identify each country in operations:	which your firm or a related firm performs the following DRAM
	DRAM module assembly:	No
	Cased DRAM assembly:	No Yes
	Uncased DRAM fabrication: □	No
II-28.	Do you always know the countrinternal transfers of DRAM mod	of fabrication and the country of assembly for your purchases and ules?
	Cased DRAM assembly:	No Yes
	Uncased DRAM fabrication: □	No □ Yes
II-27.	Do you always know the countrinternal transfers of cased DRA	of fabrication and the country of assembly for your purchases and 4s?
	□ No □ Yes	
11-26.	DRAMs?	of fabrication for your purchases and internal transfers of uncased

II-30. **EMPLOYMENT.**—Report the average number of production and related workers employed in your U.S. establishment(s) in which DRAMs and DRAM modules are produced. Also report the number of hours worked (paid) by such production and related workers, and the total wages paid to these employees. If your firm produced (whether for consumption or for sale) a combination of uncased DRAMs, cased DRAMs, and DRAM modules, please allocate workers, hours, and wages required to fabricate the uncased DRAMs first, then make an additional allocation for casing the DRAMs, and then a final allocation for assembling the DRAM module.

	Calendar years			January-September	
Item	1999	2000	2001	2001	2002
AVERAGE NUMBER OF PRODUCTION AND RELATED WORKERS (PRWS) PRODUCING: Uncased DRAMs					
Cased DRAMs					
DRAM modules					
HOURS WORKED BY PRWS PRODUCING: Uncased DRAMs (1,000 hours)					
Cased DRAMs (1,000 hours)					
DRAM modules (1,000 hours)					
WAGES PAID TO PRWS PRODUCING: Uncased DRAMs (\$1,000)					
Cased DRAMs (\$1,000)					
DRAM modules (\$1,000)					

PART III.--FINANCIAL INFORMATION

hould be conta	ncted regarding the Name and title	requested financial info	rmation?			
any contact:	Name and title					
	rame and title					
	FAX No.	Phone No.	E-n	nail addres	SS	
does your fisc	al year end (month	and day)?				
r fiscal year ch	anged during the p	periods for which data are	e being repo	orted, exp	lain below	:
during the per eted questionn nge Commission m or parent do	iod of the investigative unless they are on's EDGAR site) oes or does no	ation? If so, please subme available on the World t prepare financial s	nit copies o Wide Web	f them alo (including	ng with yo g the Secu	our rities and
documents ava	allable on the Worl	ld Wide Web?		YES	NO]
At the SEC's I	EDGAR site?					1
At some other	site? (WWW addr	ess)]
e operations w m or parent do Ms/DRAM mod	rhich indicate the copies or does no dules.	ost of production of DRA t prepare internal re	AMs/DRAN	M modules	s. cost of prod	luction of
Is and/or DRA	M modules, and p					
	Product(s)		Sha	are of sale	es	
	nting basisT AAP Ta as and statement during the pereted questionninge Commission or parent do documents available. At the SEC's I At some other operations with the second or parent do the productsPleads and/or DRAM modern of the productsPleads and products	nting basisThe financial record AAP Tax Cash sand statementsDid your firm during the period of the investigeted questionnaire unless they are nge Commission's EDGAR site) m or parent does or does not documents available on the Wor At the SEC's EDGAR site? At some other site? (WWW additional and parent does or does not does or does not does not does not does or does not does not does or does not does not does or does or does not does or do	r fiscal year changed during the periods for which data are fiscal year changed during the periods for which data are not ming basisThe financial records of your firm are prepared and and the period of the investigation? If so, please submeted questionnaire unless they are available on the Worldinge Commission's EDGAR site). In or parent does or does not prepare financial side documents available on the World Wide Web? At the SEC's EDGAR site? At some other site? (WWW address or does not prepare internal prepared for the cost of production of DRAM modules. In or parent does or does not prepare internal repared for the cost of production of DRAM modules. In or parent does or does not prepare internal repared for the cost of production of DRAM modules. In or parent does or does not prepare internal repared for the cost of products of the cost of products and for DRAM modules, and provide the share of net show the cost of products and for DRAM modules, and provide the share of net show the cost of products and for DRAM modules, and provide the share of net show the cost of products and for DRAM modules, and provide the share of net show the cost of products and for DRAM modules.	does your fiscal year end (month and day)?	r fiscal year changed during the periods for which data are being reported, expending basis The financial records of your firm are prepared on the basis of: AAP Tax Cash Other (specify) Its and statements Did your firm or your parent prepare any of the statements during the period of the investigation? If so, please submit copies of them aloeted questionnaire unless they are available on the World Wide Web (including Commission's EDGAR site). Im or parent does or does not prepare financial statements (annual reducuments available on the World Wide Web? YES At the SEC's EDGAR site? At some other site? (WWW address) Im or parent does or does not prepare internal profit-and-loss reports to operations which indicate the cost of production of DRAMs/DRAM modules. Im or parent does or does not prepare internal reports indicating the of the following control of the facilities in which and/or DRAM modules, and provide the share of net sales accounted for by nost recent fiscal year:	r fiscal year changed during the periods for which data are being reported, explain below the fiscal year changed during the periods for which data are being reported, explain below the fiscal year changed during the periods of your firm are prepared on the basis of: AAP

PART III.--FINANCIAL INFORMATION--Continued

III-6. Operations on DRAMs and DRAM modules.--Report the revenue and related cost information requested below on the DRAM/DRAM module operations of your U.S. establishment(s). Note that internal consumption and transfers to related firms must be valued at fair market value and purchases from related firms must be at cost. Please footnote any restructuring and other non-recurring items. Provide data for your three most recently completed fiscal years (calendar years may be submitted, if available) in chronological order from left to right, and for the specified interim periods. NOTE.--If your firm is only an assembler of DRAM modules or is a "fabless" producer, do not complete the table on this page.

(Value in \$1,00	0)				
Item		scal years or alendar years	January-	January-September		
			2001	2002		
NET SALES VALUES: ² Commercial sales						
Internal consumption						
Transfers to related firms						
Total net sales values						
Cost of goods sold (including for internal consumption and transfers to related firms)						
Gross profit or (loss)						
OPERATING EXPENSES: Research and development						
Selling, general and administrative expenses						
Total operating expenses						
Operating income or (loss)						
OTHER INCOME AND EXPENSES: Interest expense						
All other expense items						
All other income items						
All other income or expenses, net						
Net income or (loss) before income taxes						
Depreciation/amortization included above						

¹ Include only your U.S. manufacturing operations, i.e., include domestic sales and export sales of DRAMs and DRAM modules produced from wafers and dice fabricated in the United States, regardless of assembly location, plus foreign dice assembled in the United States.

² Less discounts, returns, allowances, and prepaid freight. The values should approximate the sum of the corresponding shipment values reported in Part II of this questionnaire.

PART III.--FINANCIAL INFORMATION--Continued

III-7. <u>Detail of net sales value of DRAMs and DRAM modules</u>.--Please provide the detail of the net sales value which should reconcile with the trade data reported in Part II. Provide data for the three most recently completed fiscal years (calendar-year data may be submitted, if available) in chronological order from left to right and the specified interim periods.

(Value in \$1,000)					
Item	□ Fiscal years or □ Calendar years			January-S	September
		I I		2001	2002
COMMERCIAL SALES: DRAMs made from U.S. dice: Cased in Korea					
Cased in the United States					
Cased in other countries					
DRAMs cased in the United States from dice made: In Korea					
In other countries					
Uncased DRAMs ¹					
DRAM modules					
Total commercial sales ²					
COMPANY TRANSFERS (INCLUDING INTERNAL CONSUMPTION): U.Sproduced cased DRAMs ³					
U.Sproduced uncased DRAMs ⁴					
DRAM modules					
Total company transfers ²					
Total net sales ²					

¹ List your customers that purchased uncased DRAMs:

² The totals should agree with the commercial sales, the combined transfers and internal consumption, and the total net sales in section III-6 for operations of DRAMs and DRAM modules.

³ Not used in the production of DRAM modules included in net commercial sales above.

⁴ Not used in the production of cased DRAMs or DRAM modules included in net commercial sales above.

PART III.--FINANCIAL INFORMATION--Continued

III-8. Capital expenditures, research and development expenditures, and asset values. --Report your firm's capital expenditures and research and development expenditures on DRAMs/DRAM modules, and the values of the property, plant, and equipment used in the production of DRAMs/DRAM modules. Provide data for your three most recently completed fiscal years (calendar-year data may be submitted, if available) in chronological order from left to right, and for the specified interim periods.

(Value in \$1,000)

	Item		□ Fiscal years or □ Calendar years			January-September	
					2001	2002	
Capital e	xpenditures						
Research	n and development expenditures						
Property	, plant, and equipment:					_	
Origina	al cost						
Book v	<i>r</i> alue						
its g effo	ce January 1, 1999, has your firm experied growth, investment, ability to raise capital parts to develop a derivative or more advanged result of imports of DRAMs or DRAM No YesMy firm has	ll, existing de nced version modules from	of the production of the produ	and production luct), or the sca	on efforts (inc ale of capital	cluding	
	Cancellation or rejection of expansion	_					
	Denial or rejection of investment prop	osal					
	Reduction in the size of capital investr	ments					
	Rejection of bank loans						
	Lowering of credit rating						
	Problem related to the issue of stocks	or bonds					
	Other (specify)						
	Does your firm anticipate any negative	e impact of i	mports of I	DRAMs and D	RAM modul	es from	
III-10.	Korea?						

Producers' Questionnaire - DRAMs and DRAM modules

PART IV.--PRICING AND RELATED INFORMATION

Information on this part of the q	uestionnaire can be obtained from Jo	ohn Giamalva (202-205-2785).
IV-1. Who should be contacted	regarding the requested pricing and	related information?
Company contact:		
• •	Name and title	
	Phone No.	E-mail address

Section IV-A.--PRICE DATA

This section requests quarterly price and quantity data concerning your firm's U.S. commercial shipments to unrelated U.S. customers of the following DRAM products during January 1999-September 2002:

Cased DRAMs:

<u>Product 1</u>.-64 megabit PC100 and PC133 SDRAM <u>Product 2</u>.-128 megabit PC100 and PC133 SDRAM <u>Product 3</u>.-256 megabit PC100 and PC133 SDRAM <u>Product 4</u>.-128 megabit DDR SDRAM

DRAM modules:

Product 5.—64 Megabyte PC100 and PC133 memory module **Product 6.**—128 Megabyte PC100 and PC133 memory module

Product: Product 1 ¹ Product 2 ¹ Product 3 ¹ Product 4 ¹							
Country where dice were fabricated: United States Korea Other countries							
ustomer type: PC	C OEMs Othe	er OEMs	All other sales				
	(Quantity ir	n units, <i>valu</i> e in	dollars)				
Month Quantity	y Value	Month	Quantity	Value			
1999:		2000:					
Jan.		Jan.					
Feb.		Feb.					
Mar.		Mar.					
Apr.		Apr.					
May		May					
June		June					
July		July					
Aug.		Aug.					
Sep.		Sep.					
Oct.		Oct.					
Nov.		Nov.					
NOV.				i			

PART IV.--PRICING AND RELATED INFORMATION--Continued

	separatery for each	combination of fab	rication sourc	e and customer ty	pe.
Product:	Product 1 ¹	Product 2 ¹	Produc	ct 3 ¹ Pro	oduct 4 ¹
Country v	vhere dice were fab	ricated: United	d States	☐ Korea	Other countries
Custome	r type: PC OEM	s Other O	EMs	All other sales	
		(<i>Quantity</i> in uni	its, <i>valu</i> e in c	iollars)	
Month	Quantity	Value	Month	Quantity	Value
2001:			2002:		
Jan.			Jan.		
Feb.			Feb.		
Mar.			Mar.		
Apr.			Apr.		
May			May		
June			June		
July			July		
Aug.			Aug.		
Sep.			Sep.		
Oct.					
Nov.					
Dec.					
	our product does not ex description of your prod		specifications	but is competitive w	ith the specified product,

V-A-3. DRAM modules sold in 1999 and 2000-COPY THIS PAGE AS NECESSARY. Complete a separate page for each of the specified DRAM modules assembled and sold by your firm in the United States. If your firm neither fabricates nor cases DRAMs in the United States, please skip this question. Please identify the product by product number and report separately for each combination of fabrication source, cased DRAM assembly source, and customer type.								
Product:	Product 5¹	Product 6¹						
Country v	vhere dice were fa	bricated: Unite	d States	Korea Othe	rcountries			
countries	_	sembled into cased			Korea Other			
		(<i>Quantity</i> in un						
Month	Quantity	Value	Month	Quantity	Value			
1999:			2000:	<u>l</u>				
Jan.			Jan.					
Feb.			Feb.					
Mar.			Mar.					
Apr.			Apr.					
May			May					
June			June					
July			July					
Aug.			Aug.					
Sep.			Sep.					
Oct.			Oct.					
Nov.			Nov.					
Dec.			Dec.					
¹ If yo	our product does not ε description of your pro	exactly meet the product duct:	et specifications	but is competitive with	the specified product,			

ty	DRAM modules sold in 2001 and January-September 2002—COPY THIS PAGE AS NECESSARY. Report separately for each of the specified DRAM modules assembled and sold by your firm in the United States. If your firm neither fabricates nor cases DRAMs in the United States, please skip this question. Please identify the product by product number and report separately for each combination of fabrication source, cased DRAM assembly source, and customer type.						
Product:	Product 5¹	Product 6¹					
Country whe	re dice were fal	oricated: Unite	d States	Korea Dotl	ner countries		
Country whe countries			∕ls ∐All of	her sales	Korea Other		
		(<i>Quantity</i> in un	<u> </u>	· · · · · · · · · · · · · · · · · · ·			
Month	Quantity	Value	Month	Quantity	Value		
2001:		_	2002:				
Jan.			Jan.				
Feb.			Feb.				
Mar.			Mar.				
Apr.			Apr.				
May			May				
June			June				
July			July				
Aug.			Aug.				
Sep.			Sep.				
Oct.							
Nov.							
Dec.							

Section IV-B.--PRICE-RELATED QUESTIONS

Please describe how your firm determines the prices that it charges for sales of DRAMs or DRAM modules (transaction by transaction negotiation, contracts for multiple shipments, set price lists, etc.). If your firm issues price lists, please include a copy of a recent price list with your submission. If your price list is large, please submit sample pages.				
Please describe your firm's discount policy (quantity discounts, annual total volume discounts, etc.).				
What are your firm's typical sales terms for its U.Sproduced DRAMs or DRAM modules (e.g., 2/10 net 30 days)? On what basis are your prices of domestic DRAMs or DRAM modules usually quoted (e.g., f.o.b. warehouse, or delivered)?				
Approximately what percentage of your firm's sales of its U.Sproduced DRAMs or DRAM modules are on a contract (percent) vs. spot sales (percent) basis? If you sell on a contract basis, please answer the following questions with respect to provisions of a typical contract.				
(a) What is the average duration of a contract?				
(b) How frequently are contracts renegotiated?				
(c) Does the contract fix quantity, price, or both?				
(d) Does the contract have a meet or release provision?				
(e) What are the standard quantity requirements, if any?				
(f) What is the price premium for sub-minimum shipments? percent				
(g) Contract prices have been on average over the past year:				
percent higher the same as percent lower than spot prices				

IV-B-5.	If you sell on a contract basis, please answer the following question with respect to provisions of a typical contract.					
	What impact does spot pricing have on contract prices?					
	(a) when contract prices are negotiated					
	(b) within the contract period					
IV-B-6a.	Has your firm entered into any long-term agreements for the supply of DRAMs or DRAM modules? If yes, please report the terms of these supply agreements (i.e., pricing, volume, duration), the share of total sales, and the firms involved.					
IV-B-6b.	Do you customers with more than one location negotiate a single contract or a single price for all locations. No YesIf Yes, please explain whether this is true for all multi-location customers or only for some, and if only for some, please elaborate on the type(s) of customers involved.					
IV-B-7.	What is the average lead time between a customer's order and the date of delivery for your firm's sales of DRAMs or DRAM modules?					
IV-B-8.	What is the approximate percentage of the total delivered cost of DRAMs or DRAM modules that is accounted for by U.S. inland transportation costs? percent. Who generally arranges the transportation to your customers' locations? Your firm or purchaser (check one). What proportion of your sales occur within 100 miles of your storage or production facility? percent. 101 to 1,000 miles? percent. Over 1,000 miles? percent.					
IV-B-9.	What is the geographic market area in the United States served by your firm's DRAMs or DRAM modules?					

IV-B-10.	a) Please describe a typical business cycle in the DRAMs market. Does the DRAMs business cycle affect your production of DRAMs or DRAM modules? If so, how?
	b) Is the DRAMs market affected by seasonal cycles (e.g. the holiday season, back-to-school season, etc.)? If so, how does this affect your production of DRAMs or DRAM modules?
IV-B-11.	Describe how easily your firm can shift its sales of DRAMs or DRAM modules between the U.S. market and alternative country markets. In your discussion, please describe any contracts, other sales
	arrangements, or other constraints (including any third-country trade barriers such as tariffs, quotas, or other non-tariff barriers) that would prevent or retard your firm from shifting DRAMs or DRAM modules between the U.S. and alternative country markets within a 12-month period. Provide any underlying assumptions, along with relevant portions of business plans or other supporting documentation, that address this issue.
IV-B-12.	What other products may be substitutes for DRAMs or DRAM modules? Please report the application(s) in which such substitution is possible.
IV-B-13.	Describe the end uses of the DRAMs or DRAM modules that you manufacture. For each end use product, what percentage of the total cost is accounted for by DRAMs or DRAM modules?

IV-B-14.		`	Inited States if known) for DRAMs or principal factors affecting changes in				
IV-B-15.	Have there been any signif modules in the past five ye		marketing of DRAMs or DRAM				
	Does your firm sell DRAMs or DRAM modules over the internet? No Yes-Please describe, noting the estimated percentage of your firm's total sales of DRAMs or DRAM modules in 2001 accounted for by internet sales. Please report the value of your firm's total U.S. commercial shipments of DRAMs and DRAM modules made to each of the following customer types during 2001:						
IV-B-17.							
	Customer type	Individual DRAMs	Modules				
PC OEM	I s						
Other Ol	EMs						
All other	r sales (distributors etc.)						
Total							
IV-B-18.		age of your firm's total U.S. DRAM as and made as DRAM modules.	and DRAM module sales in 2001 that				
	Sales as units	percent					
	Sales as modules	percent					
		100 percent					

Section IV-B.--PRICE-RELATED QUESTIONS--Continued

Please note: Subject Korean DRAMs and DRAM modules are those with dice fabricated or cased in Korea. U.S.-produced DRAMs and DRAM modules are those with U.S.-fabricated dice (except when cased in Korea) and those with dice fabricated in a third country if cased in the United States. Nonsubject DRAMs and DRAM modules are those with dice fabricated and cased in a third country.

IV-B-19.	Are the U.Sproduced and subject Korean DRAMs or DRAM modules used interchangeably (i.e., can they physically be used in the same applications)?				
	Yes NoPlease explain.				
IV-B-20.	Are the U.Sproduced and <u>NONSUBJECT</u> imported DRAMs or DRAM modules generally used interchangeably?				
	Yes NoPlease explain, by country.				
IV-B-21.	Are <u>NONSUBJECT</u> imported DRAMs or DRAM modules and subject Korean DRAMs or DRAM modules used interchangeably?				
	Yes NoPlease explain, by country.				
IV-B-22.	Are there any differences in product characteristics or sales conditions between U.Sproduced DRAMs or DRAM modules and subject Korean DRAMs or DRAM modules that are a significant factor in your firm's sales of DRAMs or DRAM modules?				
	No YesPlease describe any such advantages or disadvantages of the domestic product vis-a-vis the imported product (e.g., quality, availability, transportation network, product range, technical support, etc.).				

Section IV-B.--PRICE-RELATED QUESTIONS--Continued

Please note: Subject Korean DRAMs and DRAM modules are those with dice fabricated or cased in Korea. U.S.-produced DRAMs and DRAM modules are those with U.S.-fabricated dice (except when cased in Korea) and those with dice fabricated in a third country if cased in the United States. Nonsubject DRAMs and DRAM modules are those with dice fabricated and cased in a third country.

IV-B-23.	Are there any differences in product characteristics or sales conditions between U.Sproduced DRAMs or DRAM modules and <u>NONSUBJECT</u> imported DRAMs or DRAM modules that are a significant factor in your firm's sales of DRAMs or DRAM modules?				
	No YesPlease describe any such advantages or disadvantages of the domestic product vis-a-vis the nonsubject imported product.				
IV-B-24.	Are there any differences in product characteristics or sales conditions between NONSUBJECT imported DRAMs or DRAM modules and subject Korean DRAMs or DRAM modules that are a significant factor in your firm's sales of DRAMs or DRAM modules? \[\begin{array}{c} \text{No} \text{VesPlease describe, by country, any such advantages} \end{array}				
	of the nonsubject imported product vis-a-vis the subject Korean product.				
IV-B-25.	Using specific applications as examples where appropriate, discuss the substitutability of: a) DRAMs with different addressing modes (EDO, synchronous, DDR, Rambus, etc.)				
	b) Commodity DRAMs with specialty DRAMs (SGRAM, VRAM, WRAM, etc.)				
	c) DRAMs with differing densities (e.g. viability of substituting four 64 Meg DRAMs in an application for one 256 Meg DRAM).				

a) Do the firms to whom you sell DRAMs or DRAM modules require that your firm be qualified before they will purchase DRAMs or DRAM modules from you? If yes, please describe, in detail, t qualification process. Include in your description the steps required, the time of the process, the typ of DRAM involved, and the types of customers (PC OEM, distributor, etc.) that require qualification					
b) Subsequent to qualification of your firm, do the firms to whom you sell DRAMs or DRAM modules require that DRAMs be qualified in a specific application? If yes, please describe, in detail, the qualification process. Include in your description, the steps required, the time of the process, the type of DRAM involved, and the types of customers (OEM, distributor, etc.), that require qualification in a specific application.					
c) Since January 1, 1999, has your firm ever failed to qualify to supply DRAMs or DRAM modules to a customer? Yes No If yes, please give the date, customer name, type of DRAM, and the reason for the failure to qualify. Please also note whether your firm failed to qualify for all applications, or qualified for some applications but not others. If your firm attempted to qualify at a later date, please report the result of that attempt.					

Section IV-C.--CUSTOMER IDENTIFICATION

Please identify below the names and addresses of your firm's 10 largest customers for DRAMs or DRAM modules during January 1999-September 2002. Please also provide the name and telephone number of a contact person and the share of the quantity of your firm's total shipments of DRAMs or DRAM modules that each of these customers accounted for in 2001.

No.	Customer's name	Street address (<u>not</u> P.O. box), state, and zip code	Contact person	Area code and telephone number	Share of 2001 sales (%)
1					
2					
3					
4					
5					
6					
7					
8					
9					
10					

Section IV-D.--COMPETITION FROM IMPORTS--LOST REVENUES

THIS SECTION IS TO BE COMPLETED ONLY BY NON-PETITIONERS. (Note: petitioners may provide allegations involving quotes made AFTER the filing of the petition.) Since January 1, 1999: To avoid losing sales to competitors selling DRAMs or DRAM modules from Korea, did your firm: Yes Reduce prices Roll back announced price increases If yes, please furnish as much of the following information as possible for each affected transaction. Document such allegations of lost revenues whenever possible (documentation could include copies of invoices, sales reports, or letters from customers). Please note that the Commission may contact the firms named to verify the allegations reported. Customer name, contact person, phone and fax numbers Specific product(s) involved Date of your initial price quotation Quantity involved Your initial *rejected* price quotation (total delivered value) Your *accepted* price quotation (total delivered value) The country of origin of the competing imported product

Customer name, contact person, phone and fax numbers	Product	Date of quote	Quantity (UNITS)	Initial rejected U.S. price (total value <i>dollar</i> s)	Accepted U.S. price (total value dollars)	Country of origin	Competing import price (total valuedollars)

The competing price quotation of the imported product (total delivered value)

Section IV-E.--COMPETITION FROM IMPORTS--LOST SALES

THIS SECTION IS TO BE COMPLETED ONLY BY NON-PETITIONERS. (Note: petitioners may

provide allegations involving quotes made AFTER the filing of the petition.)
Since January 1, 1999 : Did your firm lose sales of DRAMs or DRAM modules to imports of these products from Korea?
☐ Yes ☐ No
If yes, please furnish as much of the following information as possible for each affected transaction. Document such allegations of lost sales whenever possible (documentation could include copies of invoices, sales reports, or letters from customers). Please note that the Commission may contact the firms named to verify the allegations reported.
Customer name, contact person, phone and fax numbers
Specific product(s) involved
Date of your price quotation
Quantity involved
Your rejected price quotation (total delivered value)
The country of origin of the competing imported product
The accepted price quotation of the imported product (total delivered value)

Customer name, contact person, phone and fax numbers	Product	Date of quote	Quantity (UNITS)	Rejected U.S. price (total value dollars)	Country of origin	Accepted import price (total value-dollars)